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UHF power transistor

BLT53

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FEATURES

- Emitter-ballasting resistors for an optimum temperature profile
- Gold metallization ensures
 excellent reliability
- · Withstands full load mismatch.

DESCRIPTION

NPN silicon planar epitaxial transistor encapsulated in a 4-lead SOT122D studless envelope with a ceramic cap. It is designed for common emitter, class-B operation in portable radio transmitters in the 470 MHz communications band. All leads are isolated from the mounting flange.

PINNING - SOT122D

PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter

QUICK REFERENCE DATA

RF performance at T_{mb} = 25 °C in a common emitter test circuit.

MODE OF	f	V _{CE}	PL	G _p	^ղ շ
OPERATION	(MHz)	(V)	(W)	(dB)	(%)
c.w. class-B	470	7.5	8	> 6	> 60

WARNING Product and environmental safety - toxic materials				

PIN CONFIGURATION





NJ Semi-Conductors reserves the right to change test conditions, parameters limits and package dimensions without notice information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

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SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
V _{CBO}	collector-base voltage	open emitter	-	20	V	
V _{CEO}	collector-emitter voltage	open base	-	10	lv –	
V _{EBO}	emitter-base voltage	open collector	_	3	v -	
IC, IC(AV)	collector current	DC or average value		2.5	A	
ICM	collector current	peak value f > 1 MHz	-	7.5	A	
P _{tot}	total power dissipation	RF operation; T _{mb} = 25 °C		35.5	W	
T _{stg}	storage temperature range		-65	150	°C	
Тј	junction operating temperature		_	200	°C	



THERMAL RESISTANCE

PARAMETER		MAX.	UNIT
ounting base	P _{tot} = 35.5 W;	4.9	K/W
	Dunting base		bunting base $P_{tot} = 35.5 \text{ W};$ 4.9

CHARACTERISTICS

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T_j = 25 °C.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)CBO}	collector-base breakdown voltage	open emitter; I _C = 20 mA	20	-	-	V
V _{(BR)CEO}	collector-emitter breakdown voltage	open base; I _C = 40 mA	10	-	-	V
V _{(BR)EBO}	emitter-base breakdown voltage	open collector; I _E = 4 mA	3	-	-	V
ICES	collector-emitter leakage current	V _{BE} = 0; V _{CE} = 10 V	-	-	1	mA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1.2 A	25	-	-	
f _T	transition frequency	V _{CE} = 7.5 V; I _E = 1.6 A	-	3.9	-	GHz
C _c	collector capacitance	$V_{CB} = 7.5 V;$ $I_E = I_e = 0;$ f = 1 MHz	-	24	-	pF
C _{re}	feedback capacitance	V _{CE} = 7.5 V; I _C = 0; f = 1 MHz	-	17		pF
C _{c-mb}	collector-mounting base capacitance	f = 1 MHz	-	1.2	-	pF





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0 5 10 mm ______scale

DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	с	D	D ₂	н	L	Q	α
mm	4.17 3.27	5.85 5.58	0.18 0.14	7.50 7.23	7.24 6.98	27.56 25.78	9.91 9.14	1.58 1.27	90°

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